

NOT RECOMMENDED FOR NEW DESIGN **CONTACT US**



DMN80H2D0SCTI

N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	RDS(ON)	Package	I _D T _C = +25°C
800V	$2.0\Omega@V_{GS} = 10V$	ITO220AB (Type TH)	7A

Description

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

Applications

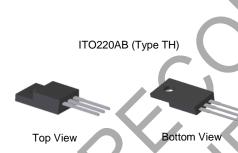
- Motor controls
- Backlighting
- DC-DC converters
- Power management functions

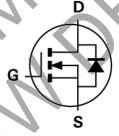
Features

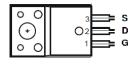
- Low Input Capacitance
- High BVDSS Rating for Power Application
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: ITO220AB
- Package Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram Below
- Weight: 1.85 grams (Approximate)







Equivalent Circuit

Top View Pin Out Configuration

Ordering Information (Note 4)

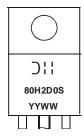
Part Number	Packing		
Part Number	Package	Qty.	Carrier
DMN80H2D0SCTI	ITO220AB (Type TH)	50 Pieces	Tube

Notes:

- EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

 4 For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



) | | = Manufacturer's Marking 80H2D0S = Product Type Marking Code YYWW = Date Code Marking YY or \underline{YY} = Last Two Digits of Year (ex: 22 = 2022) WW or WW = Week Code (01 to 53)



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V_{DSS}	800	V
Gate-Source Voltage			Vgss	±30	V
Continuous Drain Current (Note 9), V _{GS} = 10V	Steady State	$T_C = +25$ °C $T_C = +100$ °C	I _D	7 4	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) (Note 9)			IDM	28	Α
Avalanche Current (Note 6)	L = 30mH		las	2.0	Α
Avalanche Energy (Note 6)	L = 30mH		Eas	60	mJ
Peak Diode Recovery dv/dt (Note 7)			dv/dt	2.8	V/ns

Thermal Characteristics

Characteristic	Symbol	Max	Unit	
Power Dissipation (Note 5)	T _C = +25°C T _C = +100°C	PD	41 16	W
Thermal Resistance, Junction to Ambient (Note 6)		Reja	49.5	°C/W
Thermal Resistance, Junction to Case (Note 5)		Rejc	3	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

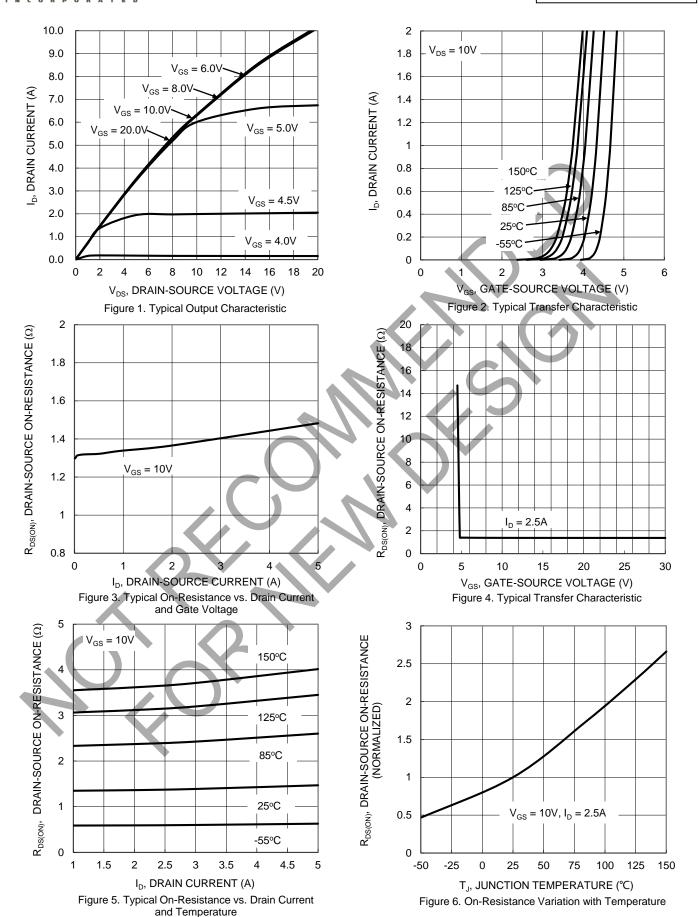
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	800		\ <u> </u>	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	Ipss	_	_	25	μΑ	V _{DS} = 800V, V _{GS} = 0V	
Gate-Source Leakage	IGSS	-	_	±100	nA	$V_{GS} = \pm 30V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	2.0	3.3	4.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	Į	1.4	2.0	Ω	$V_{GS} = 10V, I_D = 2.5A$	
Diode Forward Voltage	Vsp	7-7	0.86	1.5	V	Vgs = 0V, Is = 7.0A	
DYNAMIC CHARACTERISTICS (Note 6)							
Input Capacitance	Ciss	ا	1253	_			
Output Capacitance	Coss	<u> </u>	115	_	pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	11	_		I = I.OWINZ	
Gate Resistance	R_g	_	1.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge	Qg	_	35.4	_		101/1/ 5001/	
Gate-Source Charge	Qgs	_	5.9	_	nC	$V_{GS} = 10V, V_{DS} = 560V,$ $I_{D} = 7A$	
Gate-Drain Charge	Q_{gd}	_	16.4	_			
Turn-On Delay Time	tD(ON)	_	20.5	_	ns		
Turn-On Rise Time	tF	_	35.8	_	ns	Vgs = 10V, VDD = 350V,	
Turn-Off Delay Time	t _{D(OFF)}	_	104	_	ns	$R_G = 25\Omega$, $I_D = 7A$	
Turn-Off Fall Time	tF		42.6		ns		
Body Diode Reverse Recovery Time	trr	_	419	_	ns	$dI/dt = 100A/\mu s$, $V_{GS} = 0V$,	
Body Diode Reverse Recovery Charge	Qrr	_	4324	_	μC	IF = 7A	

Notes: 5. Device mounted on an infinite heatsink.

- 5. Device modified on an infinite heatstirk.
 6. Guaranteed by design. Not subject to production testing.
 7. l_{SD} ≤ 4.5A, dl/dt ≤ 200A/µs, V_{DD} ≤ BV_{DS}s, starting T_J = +25°C.
 8. Short duration pulse test used to minimize self-heating effect.
 9. Drain current limited by maximum junction temperature.







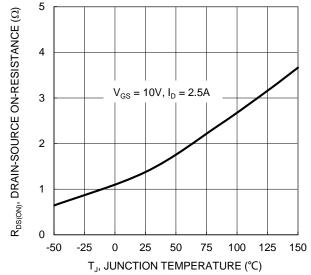


Figure 7. On-Resistance Variation with Temperature

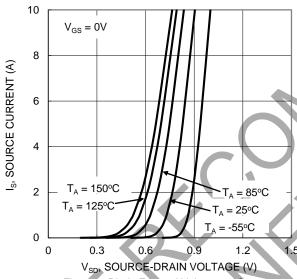
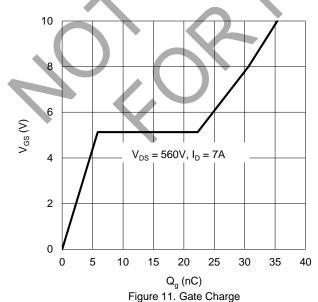


Figure 9. Diode Forward Voltage vs. Current



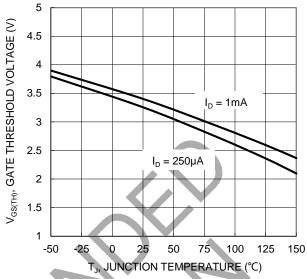


Figure 8. Gate Threshold Variation vs. Junction Temperature

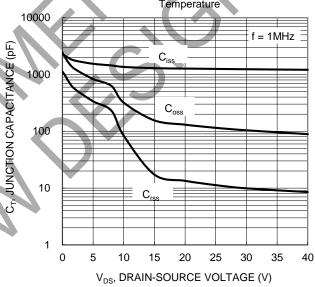


Figure 10. Typical Junction Capacitance

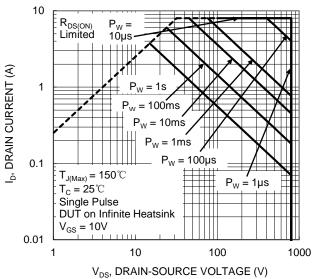


Figure 12. SOA, Safe Operation Area



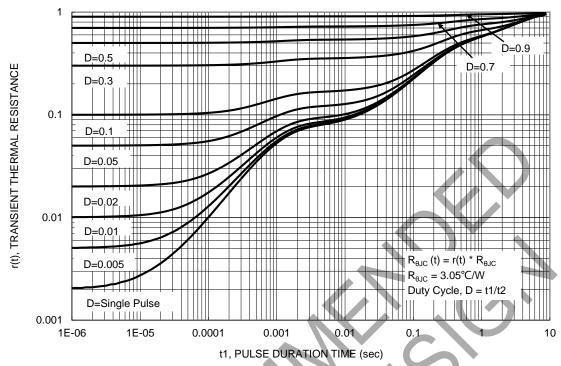


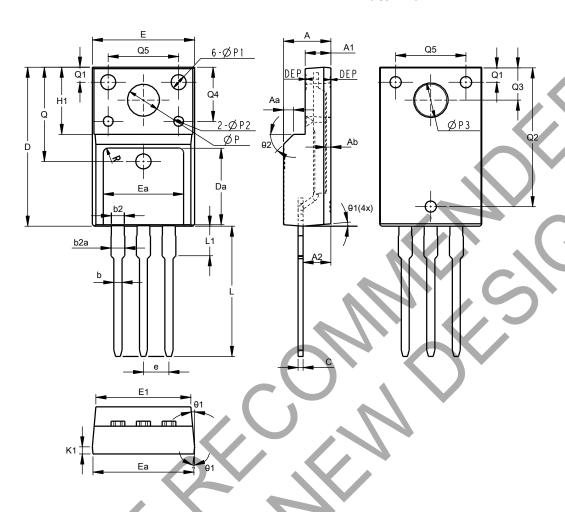
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

ITO220AB (Type TH)



ITO220AB (Type TH)						
Dim	Min	Max	Тур			
Α	4.50	4.90	4.70			
A1	2.34	2.74	2.54			
A2	2.63	2.89	2.76			
Aa	1	.00 RE	F			
Ab	0.30	0.60	0.56			
b	0.75	0.90	0.80			
b2	1.23	1.38	1.28			
b2a	1.25	1.45	1.35			
С	0.45	0.60	0.50			
D	15.47	16.27	15.87			
Da	7.55	8.05	7.80			
e	2	.54 BS				
E	9.86	10.46	10.16			
E1	9.26	9.66	9.46			
Ea	7.70	8.30	8.00			
Eb	9.76	10.04				
H1	6		F			
L	12.58	13.38	12.98			
L1	2.81	3.05	2.93			
K1	0.65	0.75	0.70			
Q	9	.40 RE	F			
Q1	1.00	2.00	1.50			
Q2	13.50	14.30	13.90			
Q3	3.15	3.45	3.30			
Q4	5.15	5.65	5.40			
Q5	6.70	7.30	7.00			
ØΡ	3.06	3.40	3.18			
ØP1	1.40	1.60	1.50			
ØP2	0.95	1.05	1.00			
ØP3	3.30	3.60	3.45			
θ1	3º	7º	5º			
θ2	-	45°	-			
R	0.50 REF					
DEP	0.05 0.15 0.10					
All Dimensions in mm						

June 2022



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